# CRMLTU0318K

#### N-Channel 30V, 515mΩ Typ. Power MOSFET

### **Description**

#### **Features**

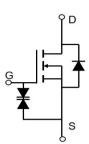
• 30V, 0.5A

 $R_{DS(ON)}$  Typ = 515m $\Omega$  @  $V_{GS}$  = 4.5V

 $R_{DS(ON)}$  Typ = 615m $\Omega$  @  $V_{GS}$  = 2.5V

- Advanced Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- Lead Free

• ESD Protected: G-S > 2KV

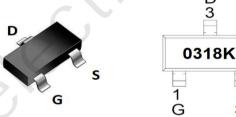








- Load Switch
- PWM Application
- Power Management



**Marking and Pin Assignment** 

#### **Package Marking and Ordering Information**

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMLTU0318K	0318K	SOT-23	TAPING	7"	3000	120000

#### Absolute Maximum Ratings (@ T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
$V_{DS}$	Drain-to-Source Voltage		30	V
V <sub>GS</sub>	Gate-to-Source Voltage		±10	V
,	Continuous Drain Current	T <sub>A</sub> = 25°C	0.5	А
I <sub>D</sub>	Continuous Drain Current	T <sub>A</sub> = 100°C	0.3	А
I <sub>DM</sub>	Pulsed Drain Current (1)		2	Α
$P_{D}$	Power Dissipation	T <sub>A</sub> = 25°C	0.35	W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient <sup>(</sup>	2)	357	°C/W
$T_J,T_STG$	Junction & Storage Temperature Range		-55 to 150	°C

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## N-Channel 30V, 515mΩ Typ. Power MOSFET

### **Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Char	acteristics					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
I <sub>GSS</sub>	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 10V$	-	-	±10	μΑ
On Char	acteristics				G	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.4	0.7	1.2	V
Б	Q	$V_{GS} = 4.5V, I_D = 0.2A$	-	515	650	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance <sup>(3)</sup>	$V_{GS} = 2.5V, I_D = 0.15A$	-	615	800	mΩ
	Characteristics					
C <sub>iss</sub>	Input Capacitance		-(	27	-	pF
$C_{oss}$	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	Χ-\	6	-	pF
$C_{rss}$	Reverse Transfer Capacitance	1 - 11011 12	7	3	-	pF
Q <sub>g</sub>	Total Gate Charge		<u></u> -	1.6	-	nC
$Q_gs$	Gate Source Charge	$V_{GS} = 0 \text{ to } 4.5V$ $V_{DS} = 15V, I_D = 0.3A$	-	0.2	-	nC
$Q_{gd}$	Gate Drain("Miller") Charge	V <sub>DS</sub> = 13V, I <sub>D</sub> = 0.3A	-	0.5	-	nC
Switchin	g Characteristics					
t <sub>d(on)</sub>	Turn-On DelayTime		-	2	-	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 30V$	-	14	-	ns
$t_{d(off)}$	Turn-Off DelayTime	$I_{D} = 0.5A, R_{GEN} = 10\Omega$	-	6	-	ns
$\mathbf{t}_{f}$	Turn-Off Fall Time		-	9	-	ns
Drain-So	urce Diode Characteristics and I	Max Ratings				
I <sub>s</sub>	Maximum Continuous Drain to Source D	iode Forward Current	-	-	0.5	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	2	А
	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 0.5A$			1.2	V

Notes:

<sup>1.</sup> Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

<sup>2.</sup>  $R_{\text{BJA}}$  is measured with the device mounted on a 1inch<sup>2</sup> pad of 2oz copper FR4 PCB

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

# **Typical Performance Characteristics**

Figure 1: Output Characteristics

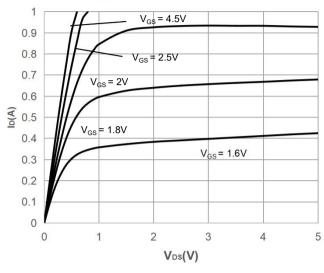


Figure 3: On-resistance vs. Drain Current

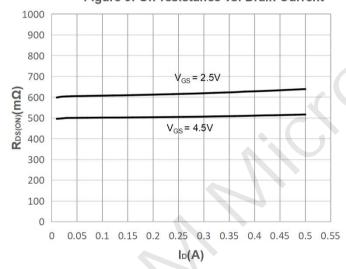


Figure 5: Gate Charge Characteristics

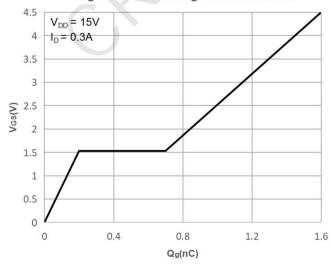


Figure 2: Typical Transfer Characteristics

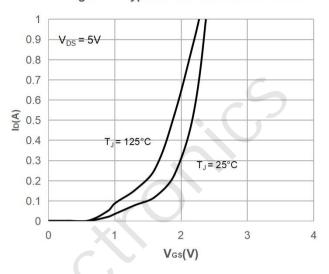


Figure 4: Body Diode Characteristics

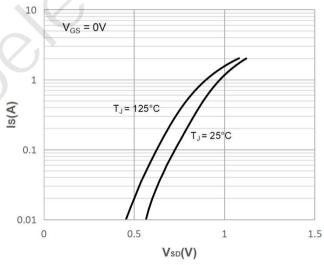
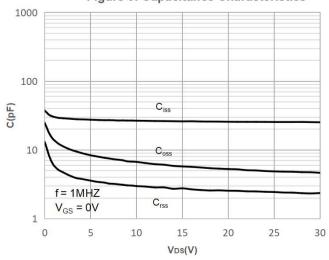


Figure 6: Capacitance Characteristics





# **Typical Performance Characteristics**

Figure 7: Normalized Breakdown voltage vs. **Junction Temperature** 

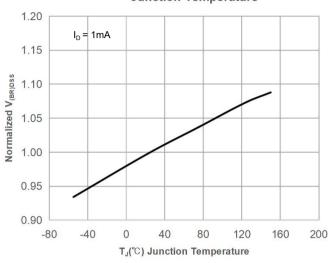
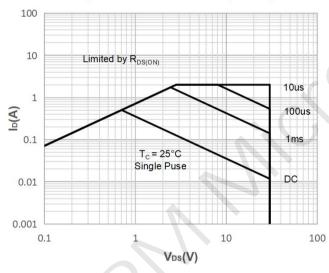


Figure 9: Maximum Safe Operating Area



**Figure 11: Normalized Maximum Transient** 

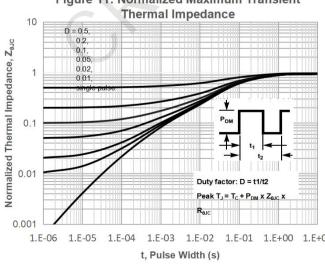


Figure 8: Normalized on Resistance vs. **Junction Temperature** 

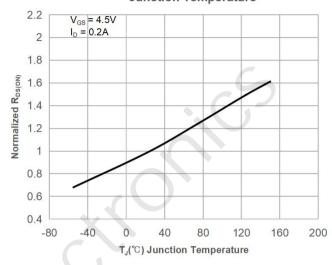


Figure 10: Maximum Continuous Drian **Current vs. Case Temperature** 

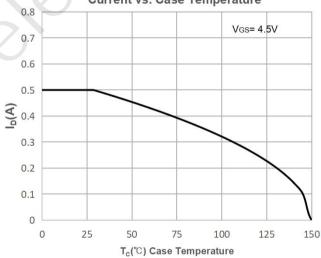
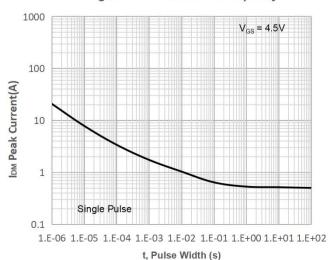


Figure 12: Peak Current Capacity



### **Test Circuit**

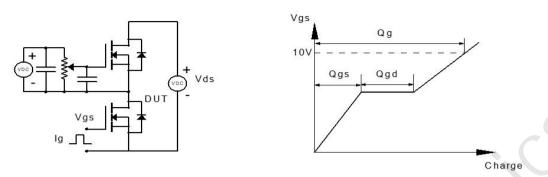


Figure 1: Gate Charge Test Circuit & Waveform

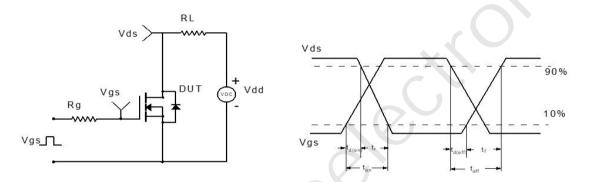


Figure 2: Resistive Switching Test Circuit & Waveform

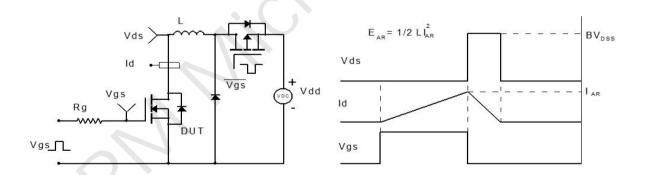


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

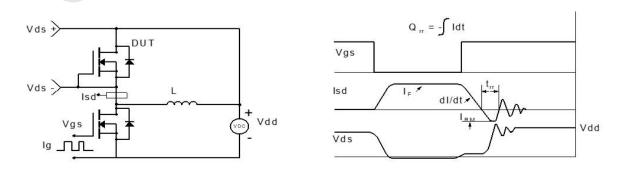
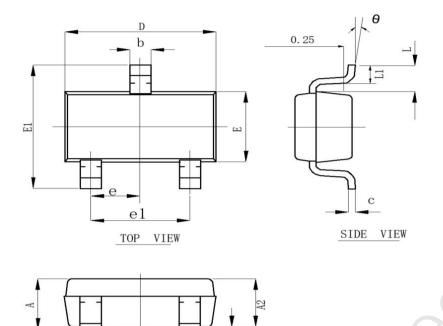


Figure 4: Diode Recovery Test Circuit & Waveform

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## Package Mechanical Data(SOT-23)



SIDE VIEW

SYMBOL	MIN	MAX	
A	0.900	1. 150	
A1	0.000	0.100	
A2	0.900	1.050	
b	0. 300	0. 500	
С	0.080	0. 150	
D	2.800	3.000	
Е	1. 200	1.400	
E1	2. 250	2.550	
L	0. 550 REF.		
θ	0°	8°	
L1	0. 300	0.500	
e	0.950 TYP.		
e 1	1.800	2.000	

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